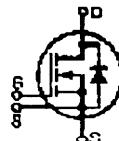


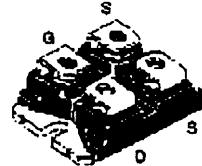
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**MegaMOS™FET****IXTN 15N100**
 $V_{DSS} = 1000 \text{ V}$   
 $I_{D25} = 15 \text{ A}$   
 $R_{DS(on)} = 0.6 \Omega$ 
**N-Channel Enhancement Mode**

Symbol	Test Conditions	Maximum Ratings	
$V_{DSS}$	$T_J = 25^\circ\text{C} \text{ to } 150^\circ\text{C}$	1000	V
$V_{DSS}$	$T_J = 25^\circ\text{C} \text{ to } 150^\circ\text{C}; R_{DS(on)} = 10 \text{ k}\Omega$	1000	V
$V_{GS}$	Continuous	$\pm 20$	V
$V_{GS}$	Transient	$\pm 30$	V
$I_{DS}$	$T_c = 25^\circ\text{C}$	15	A
$I_{DS}$	$T_c = 25^\circ\text{C}, \text{ pulse width limited by } T_{JL}$	60	A
$P_D$	$T_c = 25^\circ\text{C}$	400	W
$T_J$		-40 ... +150	$^\circ\text{C}$
$T_{JL}$		150	$^\circ\text{C}$
$T_{VTS}$		-40 ... +150	$^\circ\text{C}$
$V_{ISOL}$	50/60 Hz $I_{ISOL} \leq 1 \text{ mA}$	t = 1 min t = 1 s	2500 V- 3000 V-
$M_d$	Mounting torque Terminal connection torque (M4)	1.5/13 Nm/lb.in. 1.5/13 Nm/lb.in.	
Weight		30	g

minIBLOC, SOT-227 B  
E153432

G = Gate      D = Drain

S = Source

Either Source terminal or minIBLOC can be used as Main or Kelvin Source

**Features**

- International standard package minIBLOC (ISOTOP compatible)
- Isolation voltage 3000 V
- Low  $R_{DS(on)}$  HDMOS™ process
- Rugged polysilicon gate cell structure
- Low drain-to-case capacitance (< 50 pF)
- Low package inductance (< 10 nH)
  - easy to drive and to protect

Symbol	Test Conditions	Characteristic Values ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)			Applications
		min.	typ.	max.	
$V_{DSS}$	$V_{GS} = 0 \text{ V}, I_D = 6 \text{ mA}$	1000			V
$V_{GS(on)}$	$V_{GS} = V_{GS(on)}, I_D = 20 \text{ mA}$	2		5	V
$I_{DS(on)}$	$V_{GS} = \pm 20 \text{ V}_{DC}, V_{DS} = 0$			$\pm 500$	nA
$I_{DS(on)}$	$V_{GS} = 0.5 \cdot V_{GS(on)}$ $V_{GS} = 0 \text{ V}$	$T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$		400 $\mu\text{A}$ 2 mA	
$R_{DS(on)}$	$V_{GS} = 10 \text{ V}, I_D = 0.5 \cdot I_{DS(on)}$ Pulse test, $t \leq 300 \mu\text{s}$ , duty cycle $d \leq 2 \%$			0.6	$\Omega$

**Applications**

- AC motor speed control
- DC servo and robot drives
- Uninterruptible power systems (UPS)
- Switch-mode and resonant-mode power supplies
- DC choppers

**Advantages**

- Easy to mount with 2 screws
- Space savings
- High power density

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751

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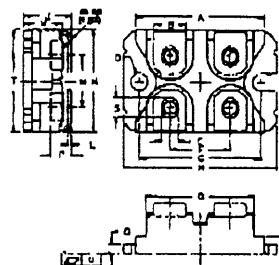
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IXTN 15N100

Symbol	Test Conditions	Characteristic Values ( $T_j = 25^\circ\text{C}$ , unless otherwise specified)		
		min.	typ.	max.
$I_{ds}$	$V_{ds} = 10 \text{ V}; I_d = 0.5 \cdot I_{ds(\text{pulsed})}$	10	28	S
$C_{iss}$ $C_{oss}$ $C_{res}$	$V_{ds} = 0 \text{ V}, V_{os} = 25 \text{ V}, f = 1 \text{ MHz}$	8000	pF	
		600	pF	
		150	pF	
$t_{q(ce)}$ $t_r$ $t_{q(on)}$ $t_f$	$V_{ds} = 10 \text{ V}, V_{os} = 0.5 \cdot V_{oss}, I_d = 0.5 I_{ds}$ $R_g = 1 \Omega$ , (External)	100	ns	
		110	ns	
		220	ns	
		105	ns	
$Q_{g(on)}$ $Q_{gs}$ $Q_{gd}$	$V_{ds} = 10 \text{ V}, V_{os} = 0.5 \cdot V_{oss}, I_d = 0.5 I_{ds}$	180	280	nC
		45	65	nC
		80	150	nC
$R_{thJC}$			0.31	K/W
$R_{thCK}$			0.05	K/W
Source-Drain Diode				
Symbol	Test Conditions	Characteristic Values ( $T_j = 25^\circ\text{C}$ , unless otherwise specified)		
		min.	typ.	max.
$I_s$	$V_{os} = 0 \text{ V}$			15 A
$I_{sd}$	Repetitive; pulse width limited by $T_{JL}$			60 A
$V_{SD}$	$I_s = I_s, V_{os} \approx 0 \text{ V},$ Pulse test, $I \leq 300 \mu\text{s}$ , duty cycle $d \leq 2 \%$			1.5 V
$t_w$	$I_F = I_B \cdot dV/dt = 100 \text{ A}/\mu\text{s}, V_R = 100 \text{ V}$	1000		ns

## miniBLOC, SOT-227 B



M4 screws (4x) supplied

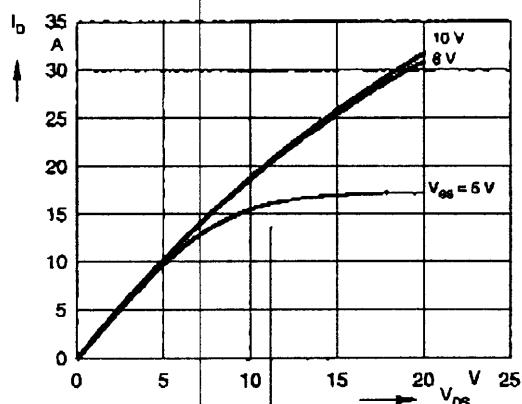
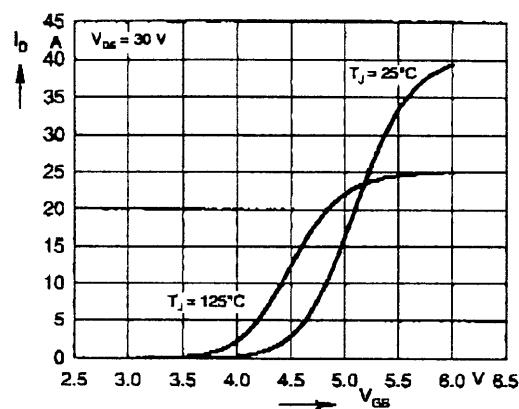
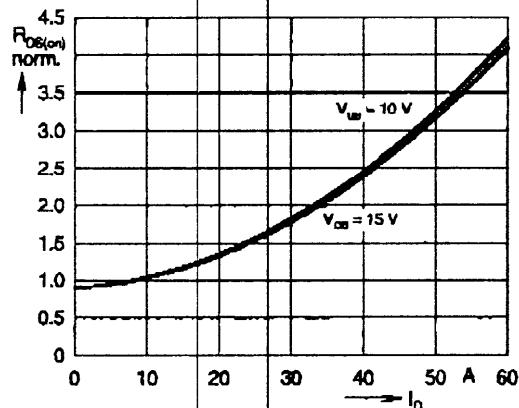
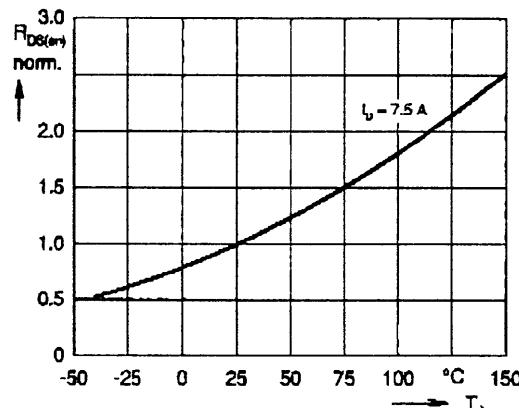
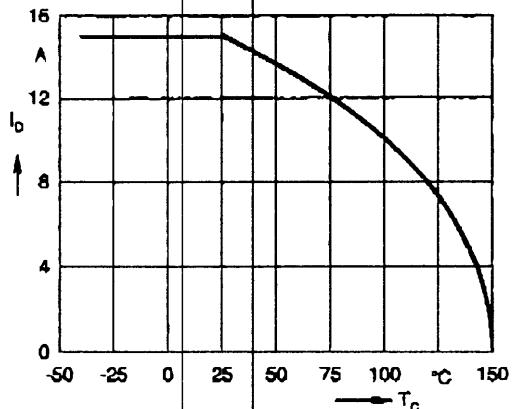
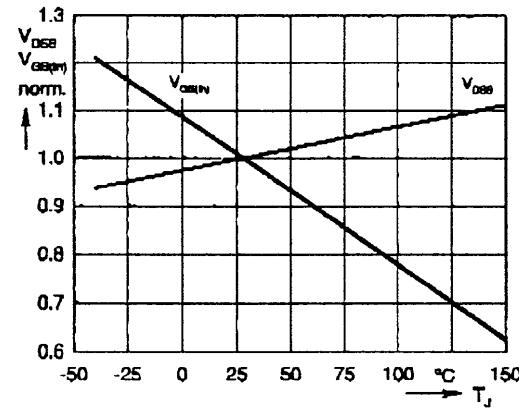
Dim.	Millimeter Min. Max	Inches Min. Max
A	31.5 31.7	1.241 1.249
B	7.8 8.2	0.307 0.323
C	4.0 -	0.158 -
D	4.1 4.3	0.162 0.169
E	4.1 4.3	0.162 0.169
F	14.9 15.1	0.587 0.595
G	30.1 30.3	1.186 1.193
H	36.0 36.2	1.497 1.505
J	11.8 12.2	0.465 0.481
K	8.9 9.7	0.351 0.382
L	0.75 0.85	0.030 0.033
M	12.6 12.8	0.496 0.504
N	25.2 25.4	0.993 1.001
O	1.95 2.05	0.077 0.081
P	- 5.0	- 0.197

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IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,692 4,881,108 5,017,508 5,048,881 5,197,117 5,486,718  
4,850,072 4,931,644 5,034,798 5,063,307 5,237,481 5,361,026

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IXTN 15N100

Fig. 1 Typical output characteristics  $I_D = f(V_{DS})$ Fig. 2 Typical transfer characteristics  $I_D = f(V_{GS})$ Fig. 3 Typical normalized  $R_{DS(on)}$  = f( $I_D$ )Fig. 4 Typical normalized  $R_{DS(on)}$  = f( $T_J$ )Fig. 5 Continuous drain current  $I_D = f(T_C)$ Fig. 6 Typical normalized  $V_{DS(on)}$  = f( $T_J$ ),  $V_{GS(on)}$  = f( $T_J$ )

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IXTN 15N100

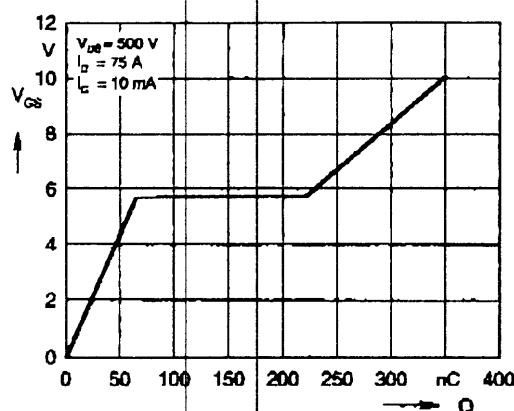
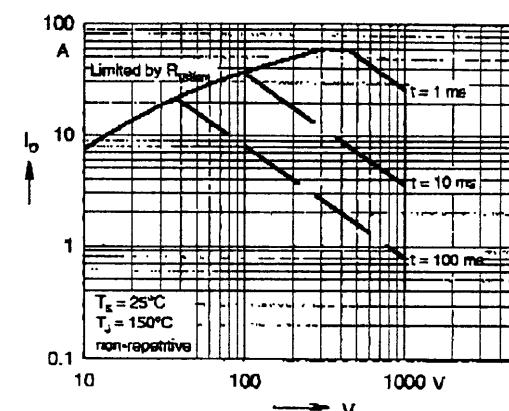
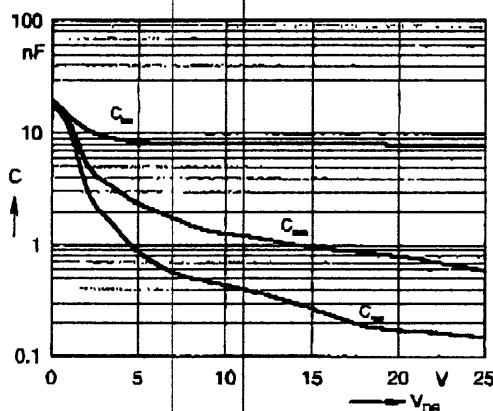
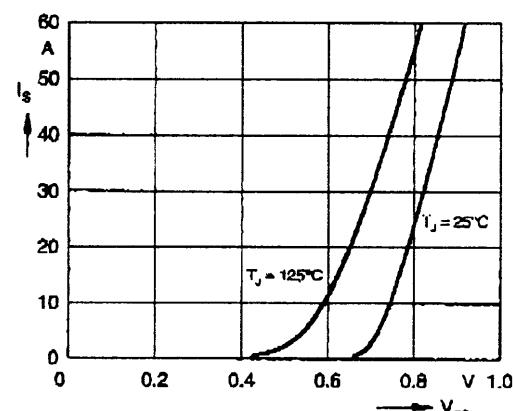
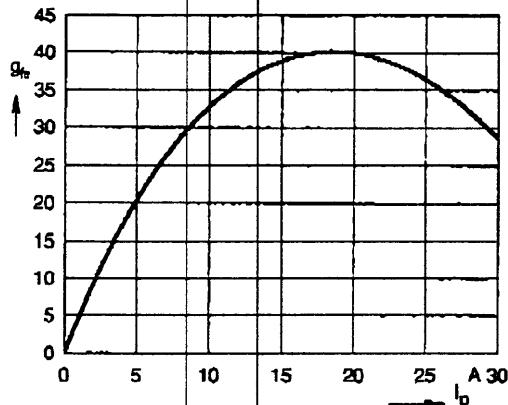
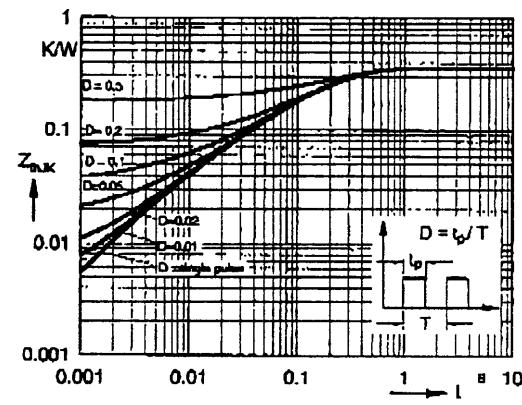


Fig. 7 Typical turn-on gate charge characteristics

Fig. 8 Forward Safe Operating Area,  $I_o = f(V_{DS})$ Fig. 9 Typical capacitances  $C = f(V_{DS})$ ,  $f = 1$  MHzFig. 10 Typical forward characteristics of reverse diode,  $I_s = f(V_{SD})$ Fig. 11 Typical transconductance  $g_m = f(I_D)$ Fig. 12 Transient thermal resistance  $Z_{th,uk} = f(t_p)$ 

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